



Research Field Matter Matter and Technologies

MT-DTS-ST2 – System Technologies

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DTS strategy meeting January 11, 2024







Helmholtz-Institut Mainz





Helmholtz-Zentrum Geesthacht Zentrum für Material- und Küstenforschung



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Achievements 2021-2023

From PFB

- MT highlights
 - 2021: Terabit per second processing with Serenity board
 - 2022: readout of cryogenic sensors
 - 2022: reinforcement learning for accelerator control

- Attracting the best talents
 - 7 PhDs, 4 with distinction
 - 2021 Faraday Cup for beam diagnostics
 - 2022 Helmholtz doctoral prize for system to readout of quantum devices
 - 2022 Honorary Prize of the Austrian Ministry of Science
 - 2023 Best paper award IEEE Conference on Network Function Virtualization and Software Defined Networks

Achievements 2021-2023

From PFB

- Publications / Open-source Software
 - 2021 6 / 0
 - 2022 13/4
 - 2023 11 / 5
- Shared hardware design and production
 DTS 100G

- Additional funding for
 - ACCLAIM: AI for beam control
 - PANDA MVD DAQ system
 - ALCYONE X-ray dosimeter for space lab
 - Ultrasound computer tomography
 - Cryo electronics lab
- Success in technology transfer



Achievements 2021-2023

From PFB

- Contributions:
 - CMS TrackTrigger
 - DAQ system for ECHo
 - Readout CUBIC
 - KATRIN data management
 - Timepix4 readout
 - Silicon photonics design tools
 - Advancing packaging facilities
 - CBM-STS detector cables
 - CMS pixel modules
 - PIXDD ASIC sensor bonding

MT-DTS working groups

ST1: Detection and Measurement M. Caselle (KIT), M. Deveaux (GSI), S. Spannagel (DESY)

Sensing

Alexander Dierlamm (KIT-IPE)

Sebastian Kempf (KIT-IMS)

Michele Caselle (KIT-IPE) Marcel Stanitzki (DESY)

Michael Fiedler (KIT-IPS, UFR)

Simon Spannagel (DESY)

ST2: System Technologies A. Kopmann (KIT) M. Guthoff (DESY)

Advanced Data Transmission <u>Karsten Hansen (DESY)</u> <u>Marc Schneider (KIT-IPE)</u>

Digital Real-time Data Acquisition and Processing Systems Luis Ardila, <u>Oliver Sander (</u>KIT-IPE) Suren Chilingaryan (KIT-IPE)

ASICs <u>Ulrich Trunck</u> (DESY) Ivan Peric (KIT-IPE) Steven Worn (DESY-Zeuthen)

20.11.2023

Novel Engineering Techniques, Advanced Materials and Interconnects <u>Thomas Blank</u>, M. Caselle (KIT-IPE) Moritz Guthoff (DESY) Karsten Hansen (DESY) Christian Schmidt (GSI) ST3: Science Systems C. Schmidt (GSI) C. Wunderer (DESY)

Particle Physics, Hadrons & Nuclei

Silvia Masciocchi, <u>Christoph Caesar (</u>GSI) Christian Enss (KIT-IPE, U HD) Volker Tympel (HI Jena) Frank Simon (KIT-IPE)

Photon Science

<u>Michael Fiederle (</u>KIT-IPS, U FR) <u>David Pennicard (</u>DESY)

Astroparticle Physics <u>Matthias Balzer (</u>KIT-IPE) <u>Steven Worm (</u>DESY-Zeuthen) Andreas Haungs (KIT-IAP)

> Beam Physics Michele Caselle (KIT)

Summary of new topics in PoF V

List of received and expected project templates

DAQ

- Data transfer and reduction for X-ray cameras; receiving and reducing X-ray data using PCs with accelerator cards
- Real-time data acquisition for ultrasound tomography
- Readout quantum devices
 - DAQ system for KATRIN++ with megapixel quantum sensors

- Computing & Algorithms:
 - Software-defined DAQ
 - Low frequency 3D ultrasound tomography device for highly advanced imaging algorithms
 - Computer Aided Diagnosis using multimodal AI



Summary of new topics in PoF V

List of received and expected project templates

- Packaging and interconnect:
 - 3D integration and fast prototyping
 - 3D stacking and interposer technologies
 - Silicon interposer; micro channel cooling for Photon Science detector systems
 - CMUT based ultrasound transducer arrays; application: wearable ultrasound tomography

- Advanced materials:
 - Micro channel cooling
 - Thermal materials for detector applications
 - Novel 3D printing techniques (?)
- Silicon photonics: packaging for 3Dintegration, component design, demonstrator
- Silicon photonics for detectors: monotithic approach

Key applications in PoF V

From DESY, GSI, HI-Jena, KIT

- Limited funding requires wise focus
- Criteria:
 - Larger interest in the centers
 - Cutting-edge technology
 - Existing pre-work
 - Good effort to impact ration, matching group size

- Example: topics under discussion in KIT
 - Quantum sensors for
 - KATRIN with 1MPixel
 - Cosmology
 - X-ray spectroscopy
- Ultrafast beam diagnostics
- Quantum computing
- Health technologies
- LHC, FCC detector and DAQ development

Foreseeable changes in PoF V

Trends, new topics, new groups

- Scalable readout system systems for quantum devices will be more requested according with larger sensor production
- Applications fields: sensors, qubits
- Data rates will continue to increase. Need for efficient reduction, trigger, by intelligence (also AI), team up with computing centers
- Silicon photonics: demonstrators will need suitable packaging technologies
- Custom packaging technologies for specific constrains

- There are new groups and topics:
 - Frank Simon, interest in high energy physics, calorimetry
 - Sebastian Kempf, design and production of superconding quantum sensors
 - Cangri Ulusoy, HF technology

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 Professorship on intelligent DAQ systems

MTE

Detector Technology and Systems (DTS)



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